



# PDTA143ZM

50 V, 100 mA PNP resistor-equipped transistor;  
R1 = 4.7 k $\Omega$ , R2 = 47 k $\Omega$

23 January 2024

Product data sheet

## 1. General description

PNP Resistor-Equipped Transistor (RET) in an ultra small SOT883 (SC-101) Surface-Mounted Device (SMD) plastic package.

NPN complement: PDTC143ZM

## 2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

## 3. Applications

- Digital application in automotive and industrial segments
- Cost-saving alternative for BC847/857 series in digital applications
- Controlling IC inputs
- Switching loads

## 4. Quick reference data

Table 1. Quick reference data

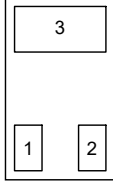
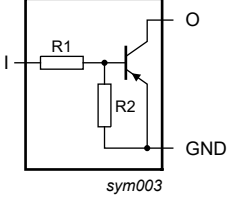
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	-50	V
I <sub>O</sub>	output current			-	-	-100	mA
R1	bias resistor 1 (input)	T <sub>amb</sub> = 25 °C	[1]	3.3	4.7	6.1	k $\Omega$
R2/R1	bias resistor ratio		[1]	8	10	12	

[1] See section "Test information" for resistor calculation and test conditions

50 V, 100 mA PNP resistor-equipped transistor; R1 = 4.7 kΩ, R2 = 47 kΩ

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)	 <p>Transparent top view</p> <p><b>DFN1006-3 (SOT883)</b></p>	 <p>sym003</p>
2	GND	ground (emitter)		
3	O	output (collector)		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">PDTA143ZM</a>	DFN1006-3	plastic, leadless ultra small package; 3 terminals; 0.35 mm pitch; 1 mm x 0.6 mm x 0.48 mm body	<a href="#">SOT883</a>

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PDTA143ZM	DP

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	-50	V
$V_{CEO}$	collector-emitter voltage	open base	-	-50	V
$V_{EBO}$	emitter-base voltage	open collector	-	-5	V
$V_I$	input voltage		-30	5	V
$I_O$	output current		-	-100	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1] [2]	250	mW
$T_j$	junction temperature		-	150	°C
$T_{amb}$	ambient temperature		-65	150	°C
$T_{stg}$	storage temperature		-65	150	°C

[1] Reflow soldering is the only recommended soldering method.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB) with 70 μm copper strip line, standard footprint.

50 V, 100 mA PNP resistor-equipped transistor; R1 = 4.7 kΩ, R2 = 47 kΩ

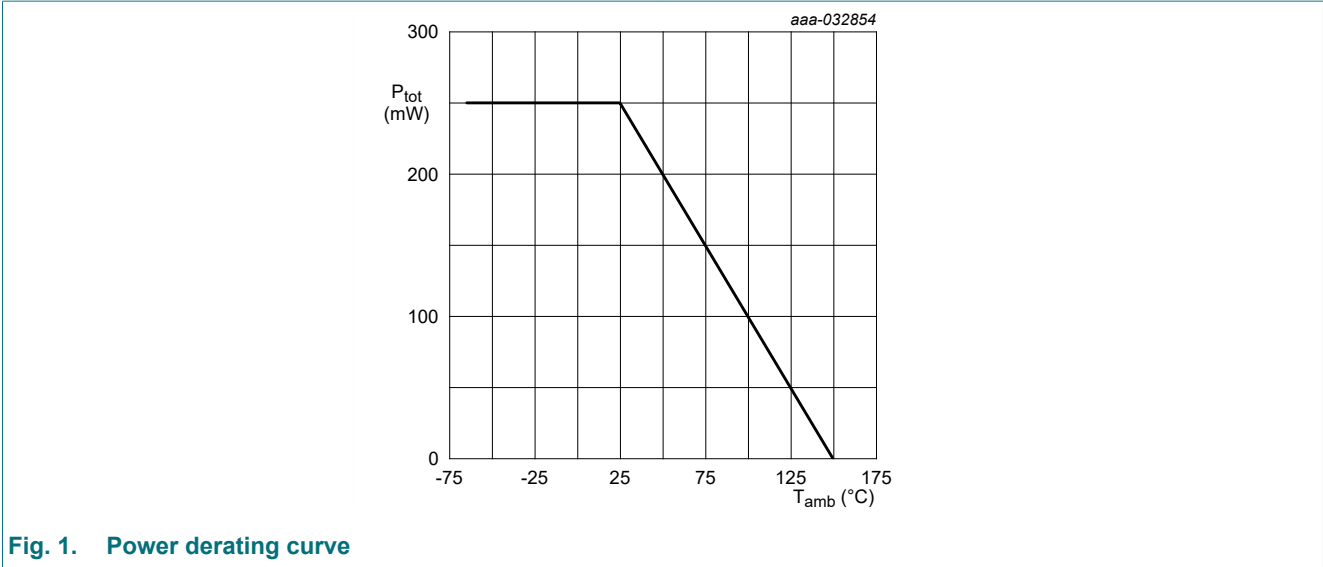


Fig. 1. Power derating curve

## 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	[1] [2]	-	-	500	K/W

- [1] Reflow soldering is the only recommended soldering method.
- [2] Device mounted on an FR4 PCB with 70 μm copper strip line, standard footprint.

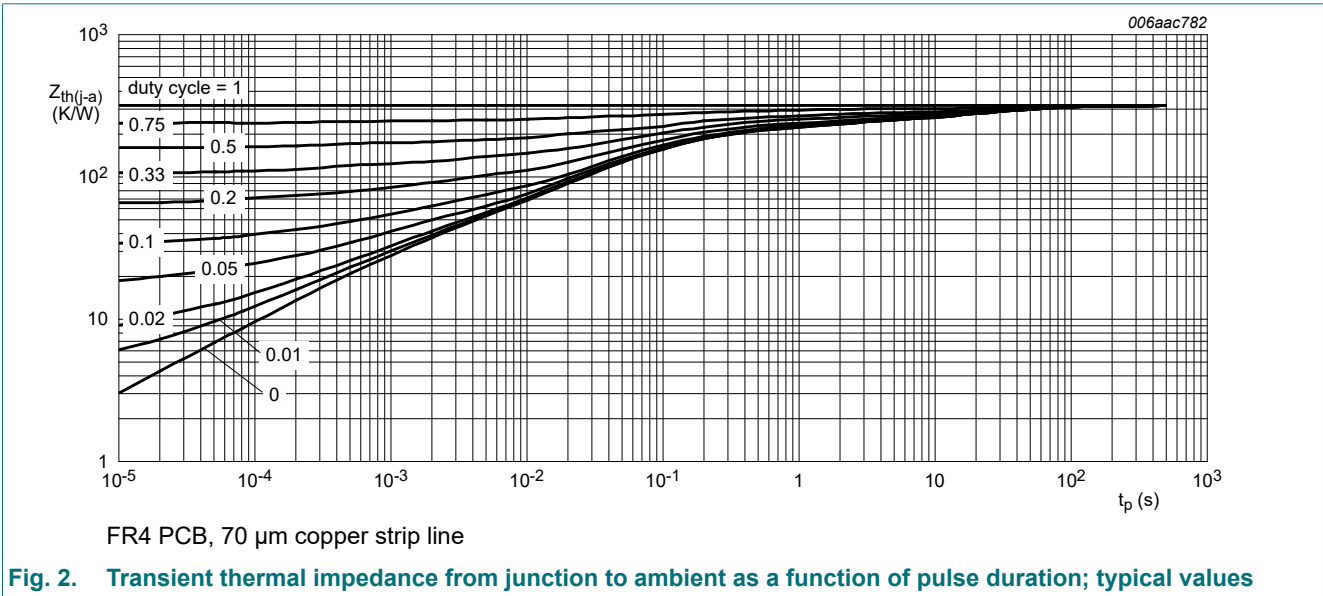


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

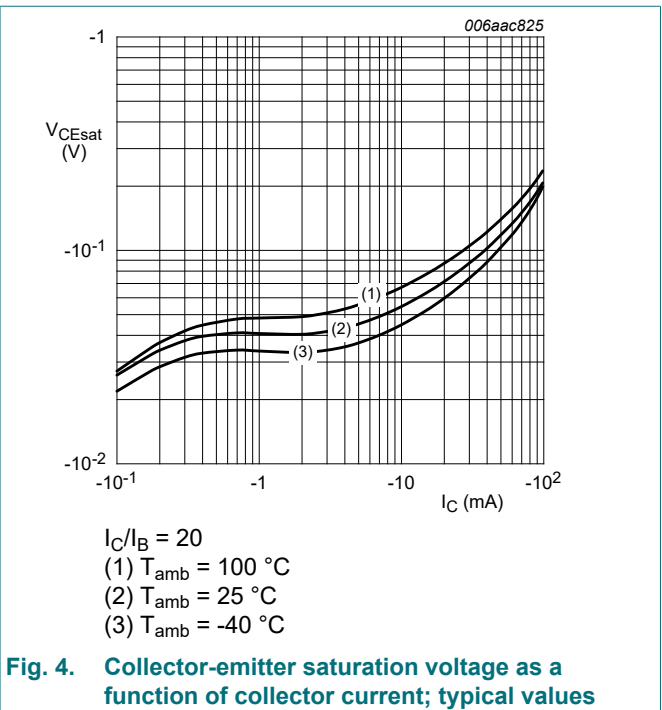
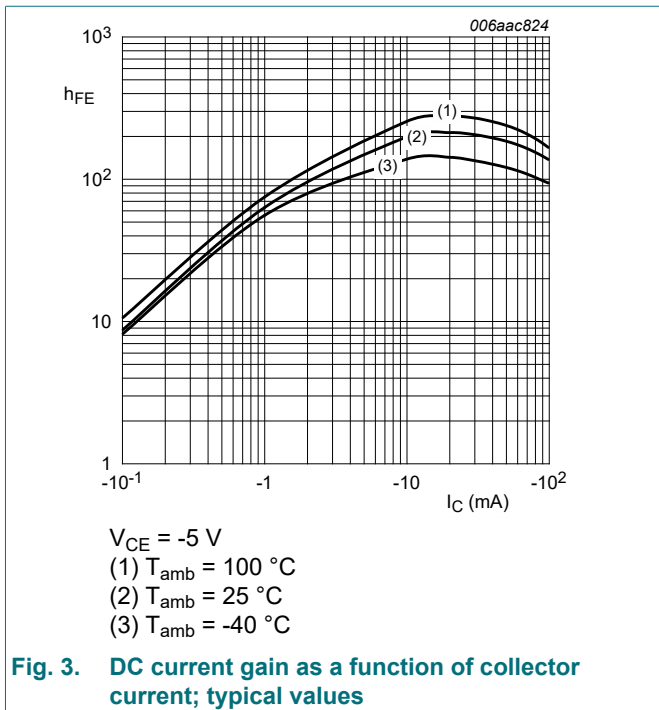
## 10. Characteristics

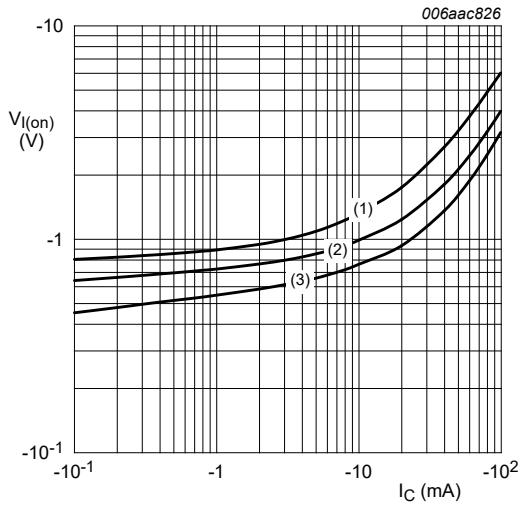
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = -100 \mu\text{A}; I_E = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-50	-	-	V	
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = -2 \text{ mA}; I_B = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-50	-	-	V	
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_C = 0 \text{ A}; I_E = -100 \mu\text{A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-5	-	-	V	
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	-100	nA	
$I_{CEO}$	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_B = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	-1	$\mu\text{A}$	
		$V_{CE} = -30 \text{ V}; I_B = 0 \text{ A}; T_j = 150 \text{ }^\circ\text{C}$	-	-	-5	$\mu\text{A}$	
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	-170	$\mu\text{A}$	
$h_{FE}$	DC current gain	$V_{CE} = -5 \text{ V}; I_C = -10 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	100	-	-		
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -5 \text{ mA}; I_B = -0.25 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	-100	mV	
$V_{I(off)}$	off-state input voltage	$V_{CE} = -5 \text{ V}; I_C = -100 \mu\text{A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-0.6	-0.5	V	
$V_{I(on)}$	on-state input voltage	$V_{CE} = -0.3 \text{ V}; I_C = -5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-1.3	-0.9	-	V	
R1	bias resistor 1 (input)	$T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[1]	3.3	4.7	6.1	kΩ
R2/R1	bias resistor ratio		[1]	8	10	12	
$C_c$	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = 0 \text{ A}; i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	3	pF	
$f_T$	transition frequency	$V_{CE} = -5 \text{ V}; I_C = -10 \text{ mA}; f = 100 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	[2]	-	180	-	MHz

[1] See section "Test information" for resistor calculation and test conditions

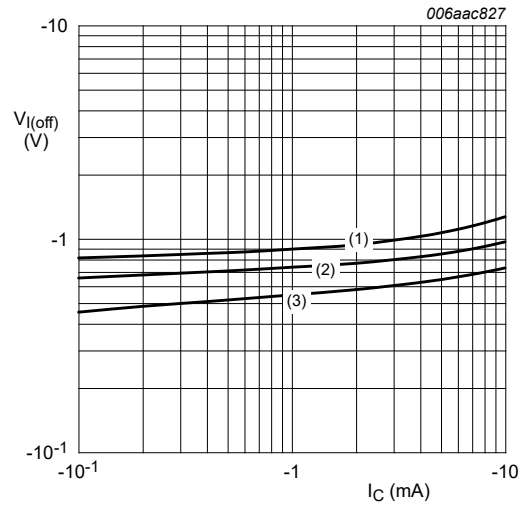
[2] Characteristics of built-in transistor





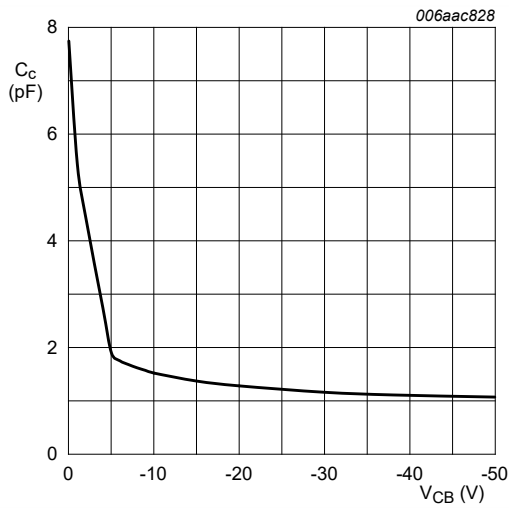
$V_{CE} = -0.3\text{ V}$   
 (1)  $T_{amb} = -40\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 5. On-state input voltage as a function of collector current; typical values**



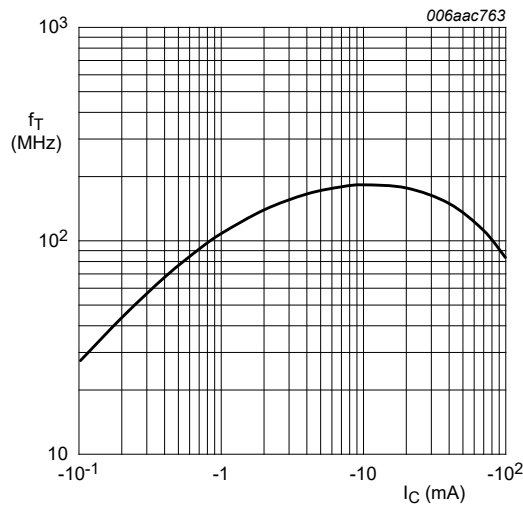
$V_{CE} = -5\text{ V}$   
 (1)  $T_{amb} = -40\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 6. Off-state input voltage as a function of collector current; typical values**



$f = 1\text{ MHz}$ ;  $T_{amb} = 25\text{ °C}$

**Fig. 7. Collector capacitance as a function of collector-base voltage; typical values**



$V_{CE} = -5\text{ V}$ ;  $T_{amb} = 25\text{ °C}$

**Fig. 8. Transition frequency as a function of collector current; typical values of built-in transistor**

## 11. Test information

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R_1 = \frac{V(I_2) - V(I_1)}{I_2 - I_1}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R_2}{R_1} = \frac{V(I_4) - V(I_3)}{R_1 \cdot (I_4 - I_3)} - 1$$

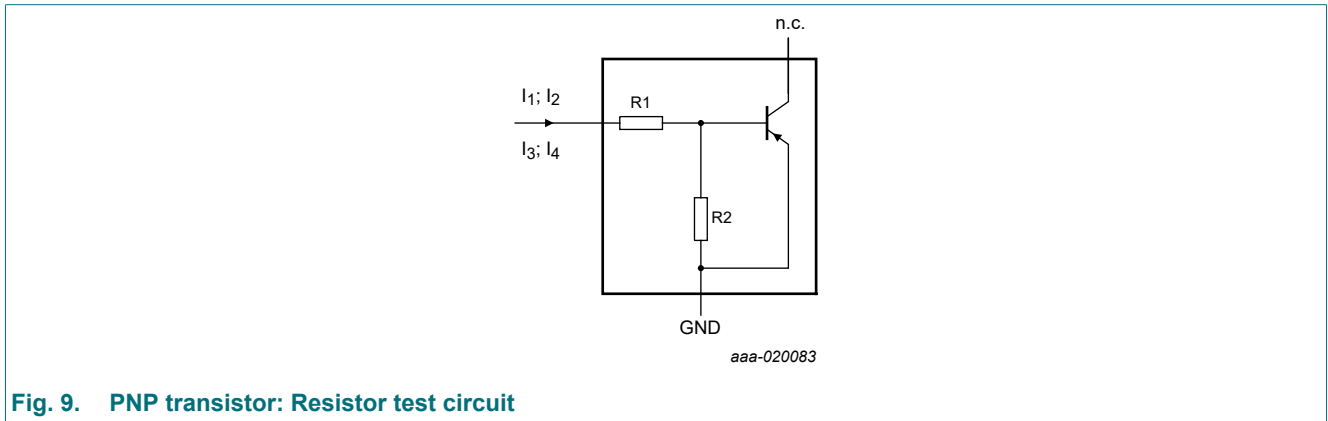


Fig. 9. PNP transistor: Resistor test circuit

### Resistor test conditions

Table 8. Resistor test conditions

Type number	R1 (kΩ)	R2 (kΩ)	Test conditions			
			I <sub>1</sub>	I <sub>2</sub>	I <sub>3</sub>	I <sub>4</sub>
PDTA143ZM	4.7	47	-90 μA	-140 μA	55 μA	105 μA

## 12. Package outline

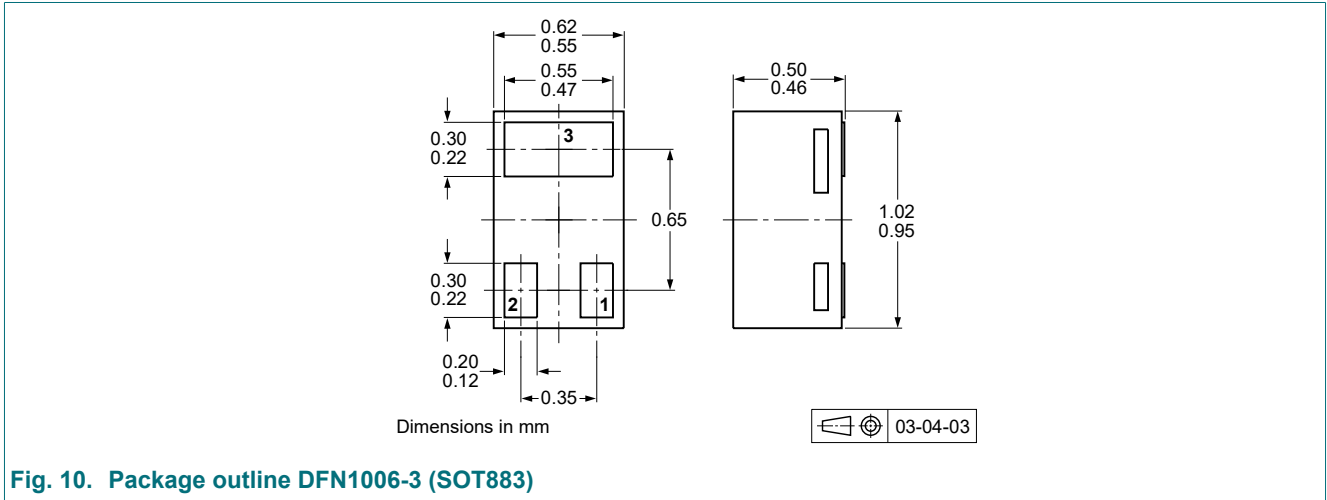


Fig. 10. Package outline DFN1006-3 (SOT883)

### 13. Soldering

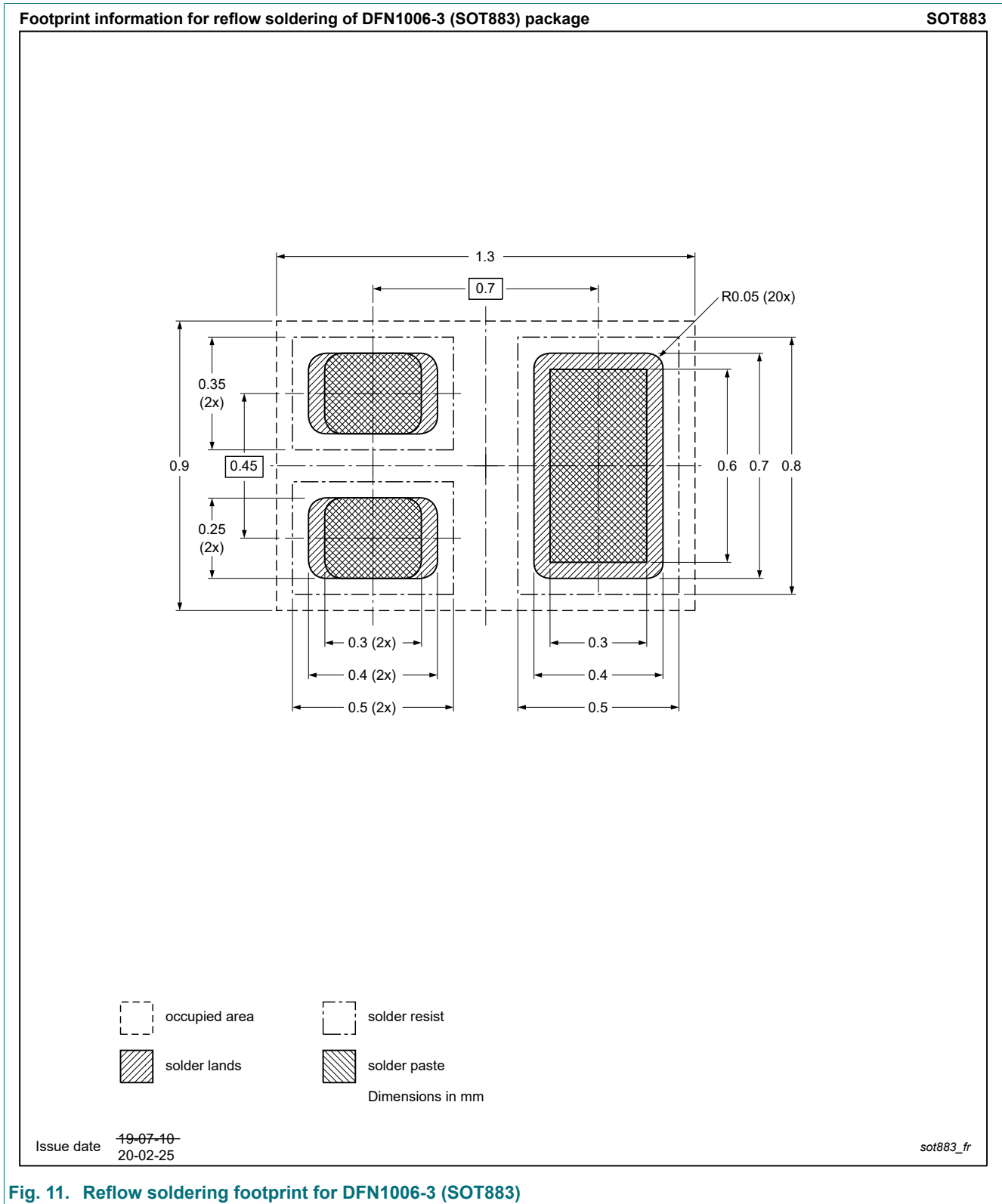


Fig. 11. Reflow soldering footprint for DFN1006-3 (SOT883)



## 14. Revision history

Table 9. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PDTA143ZM v.8	20240123	Product data sheet	-	PDTA143Z_SER v.7
Modification:	<ul style="list-style-type: none"> <li>Family data sheet reduced to single type data sheet.</li> <li>Packing information removed.</li> </ul>			
PDTA143Z_SER v.7	20111205	Product data sheet	-	PDTA143Z_SERIES v.6
PDTA143Z_SERIES v.6	20040805	Product data sheet	-	PDTA143Z_SERIES v.5
PDTA143Z_SERIES v.5	20030908	Product specification	-	PDTA143Z_SERIES v.4
PDTA143Z_SERIES v.4	20030410	Product specification	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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